

# Electro-Thermo-Mechanical Modeling in FLOORS

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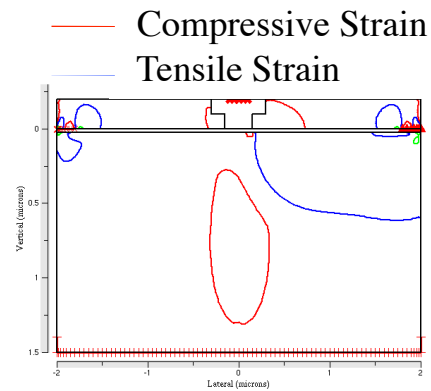
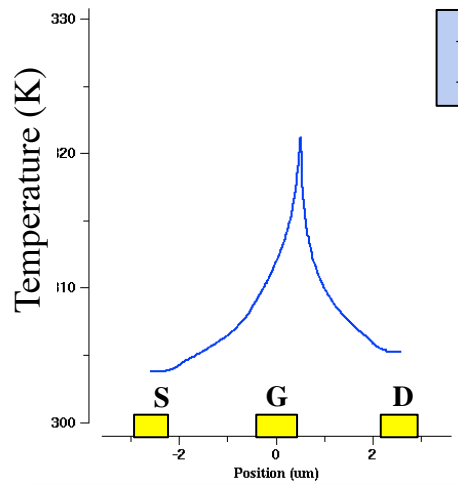
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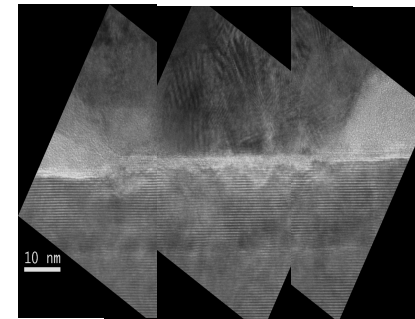
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# FLOORS

## Electro-Thermo-Mechanical Modeling



Defect Modeling → Device Performance Prediction



$t=0$ , As Built

$t>0$ , Degradation

# Electro-Thermo-Mechanical Simulation

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Electrical:

Poisson's Eq.

$$\nabla^2 \Psi = -\frac{q}{\varepsilon}(p - n)$$

Electron/Hole Continuity Eq.

$$\frac{dn}{dt} = \frac{1}{q} \nabla \cdot J_n$$

$$J_n = -q\mu_n n \nabla \phi_n$$

Thermal:

Heat Conduction Eq.

$$c \frac{\partial T}{\partial t} - \nabla \cdot K \nabla T = Q \quad \text{where,}$$

$$Q = J_n^2 \frac{1}{q\mu_n n}$$

Mechanical:

Equilibrium Eq.

$$\nabla \cdot \sigma + F = 0$$

where,

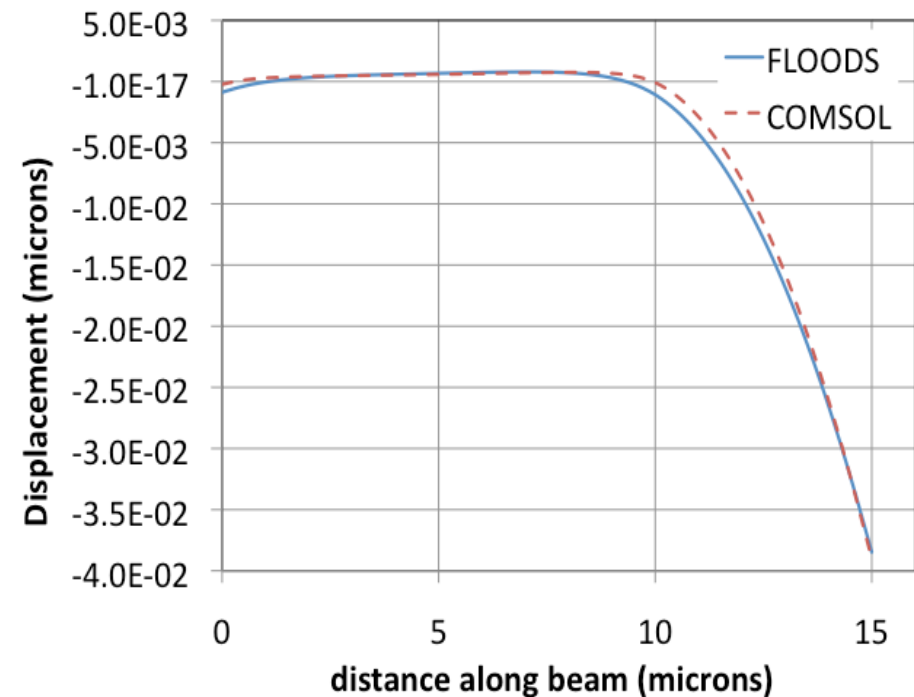
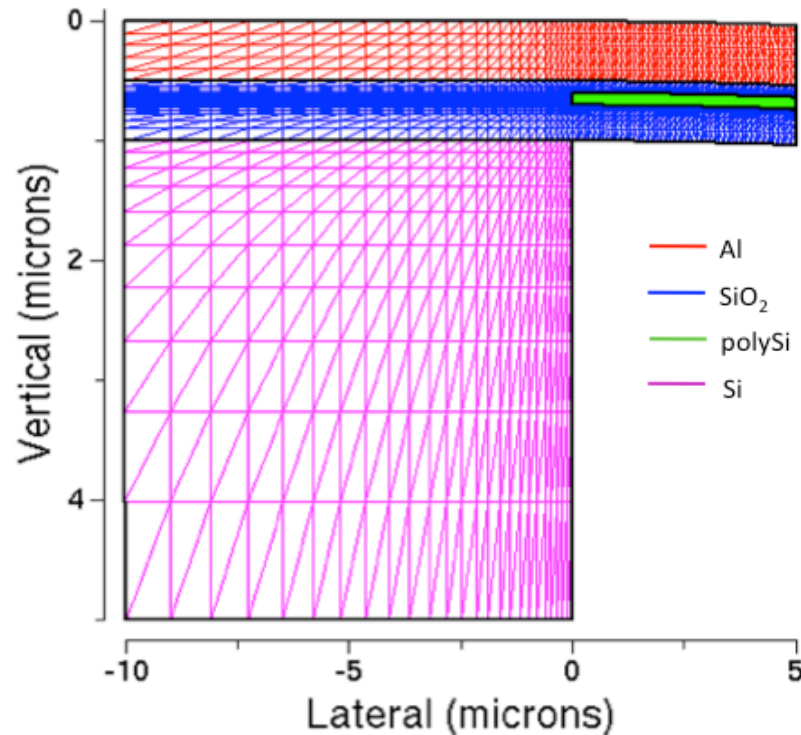
$$\sigma = D (\epsilon - \epsilon_0) \quad D(T)$$

$$\epsilon_0 = \nabla \Psi \cdot d_{pz}$$

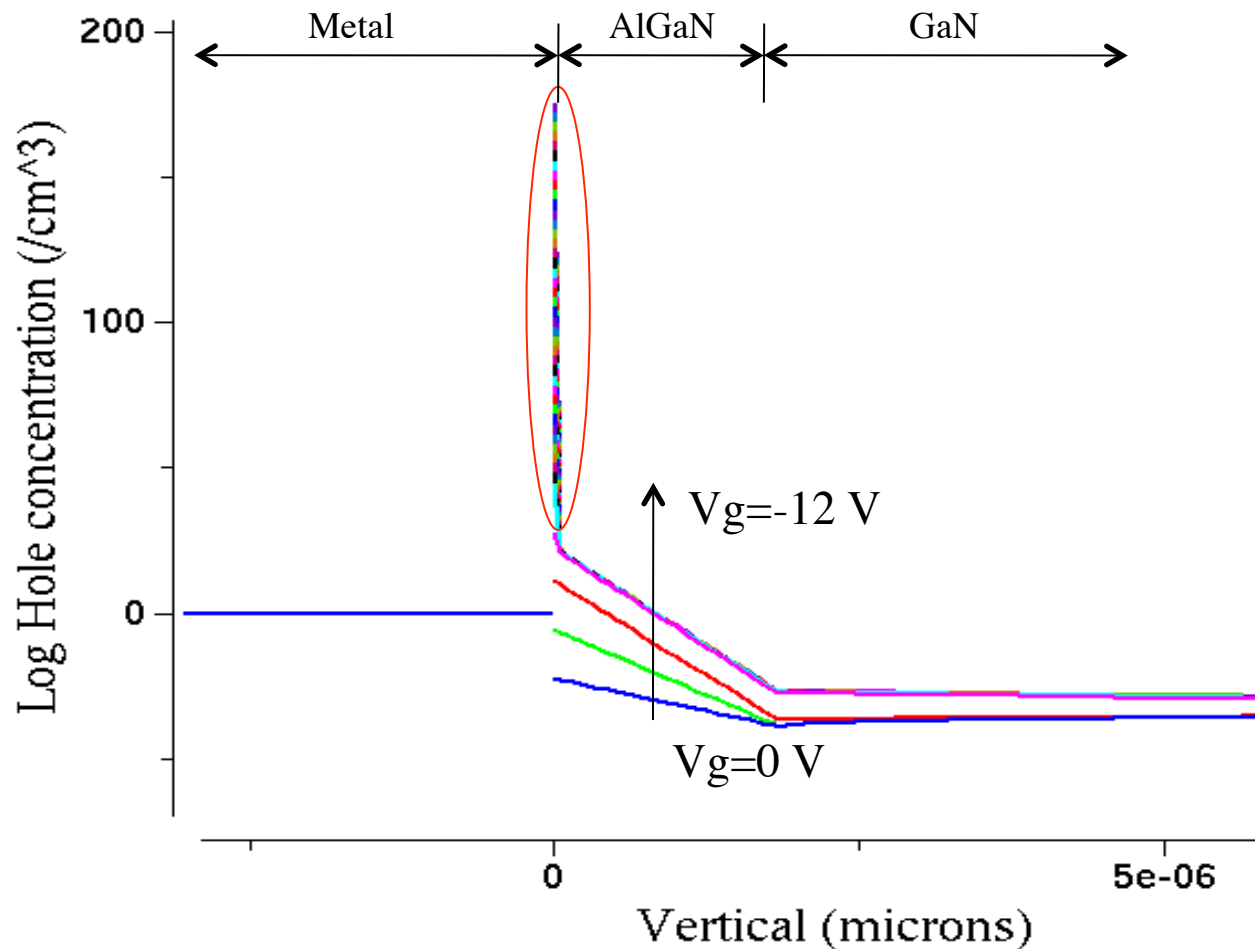
$$\epsilon_0 = \alpha_{mismatch} \Delta T$$

# ETM Simulation Validation with COMSOL

2-D MEMS thermal actuator with 3V bias across the polySilicon heater



# FLOORS Convergence Issues



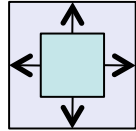
Nonconvergence  
after  $V_g = -12$  V  
( $V_{ds} = 0$  V)

Hole conc.  $\approx 1 \times 10^{19} / \text{cm}^3$   
at Metal/AlGaIn interface

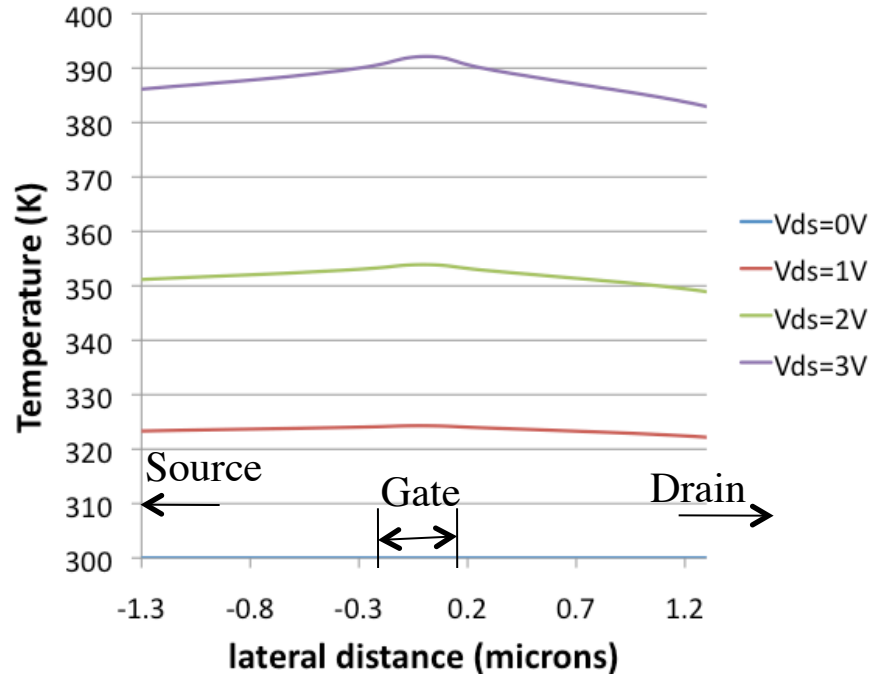
Solution: Add physics for  
gate leakage mechanism  
to provide a boundary  
condition.

# FLOORS Capability: ETM Simulation

Isotropic Thermal Expansion



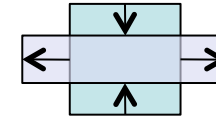
$$\epsilon_0 = \alpha_{mismatch} \Delta T$$



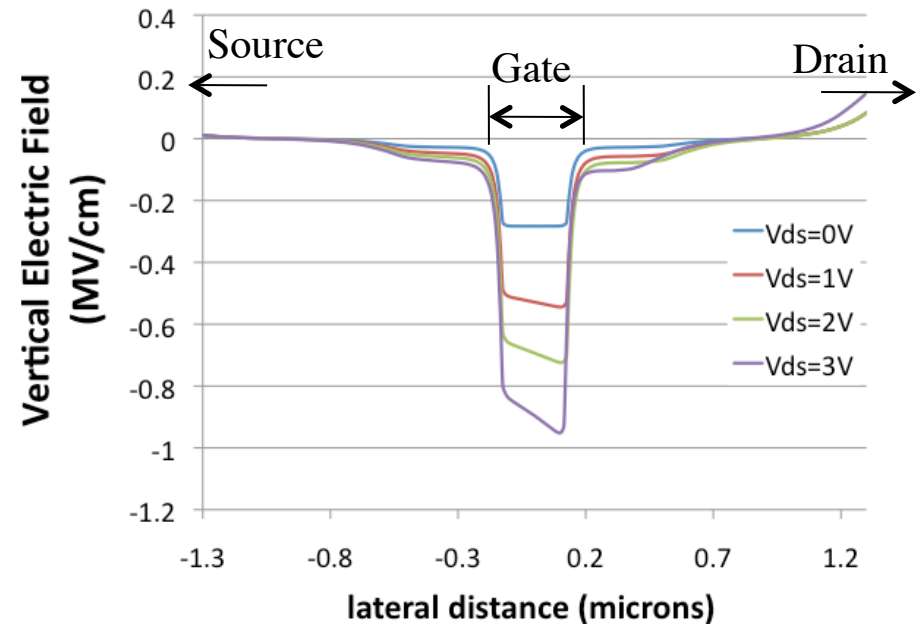
$$\sigma = D (\epsilon - \epsilon_0)$$

$$D(T)$$

Inverse Piezoelectric Effect

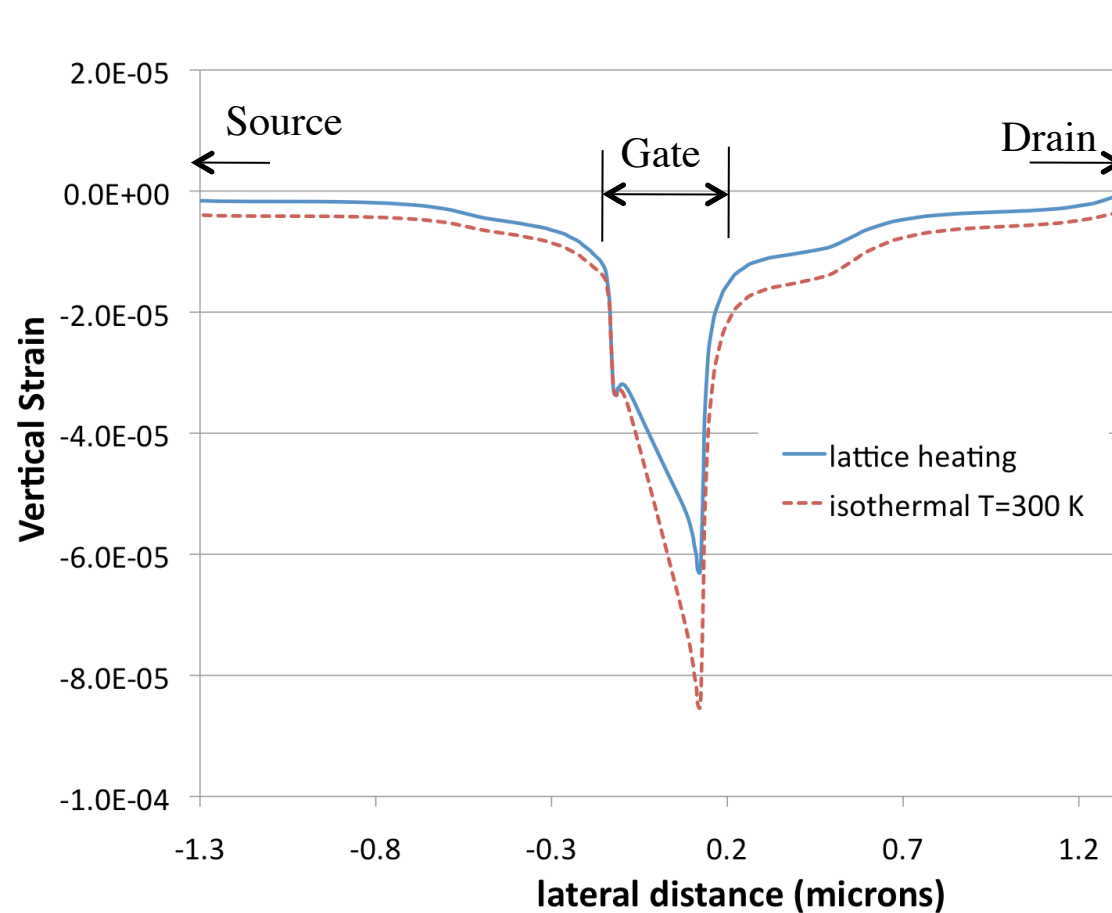


$$\epsilon_0 = \nabla \Psi \cdot d_{pz}$$



Slice taken 15nm below AlGaIn surface

# FLOORS Capability: ETM Simulation



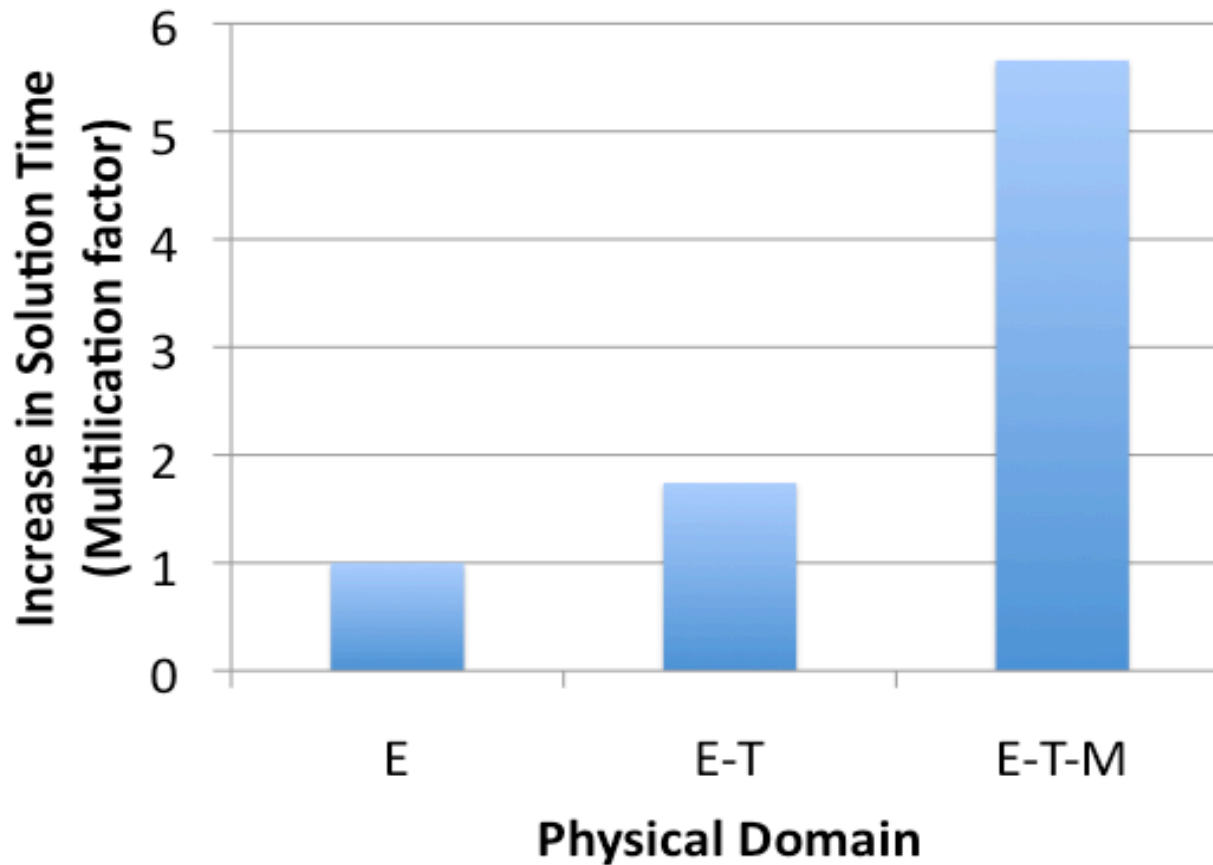
$V_{gs}=0.0$  V  
 $V_{ds}=3.0$  V

Reduction in compressive strain due to:

- 1) thermal expansion
- 2) decrease in Young's modulus with increasing temperature

# FLOORS Capability: ETM Simulation

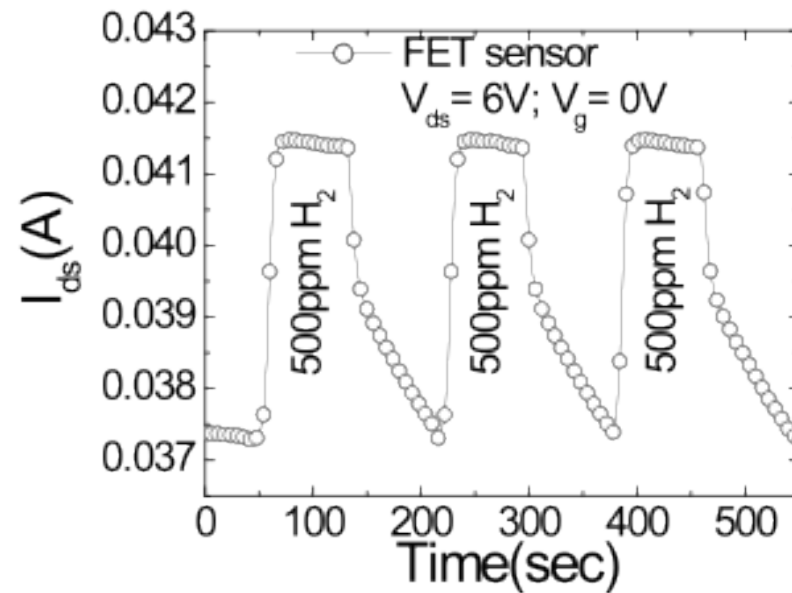
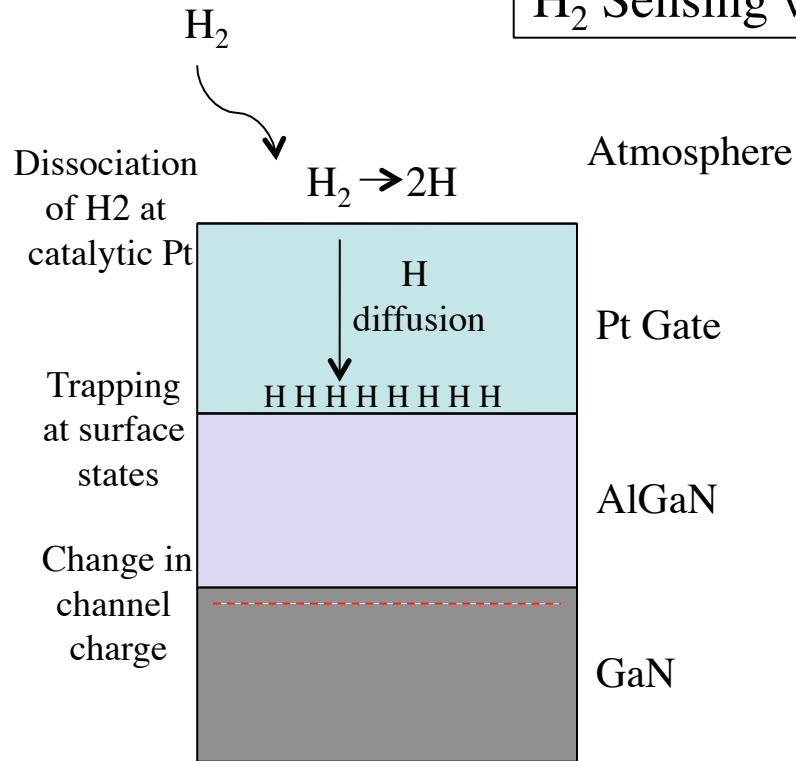
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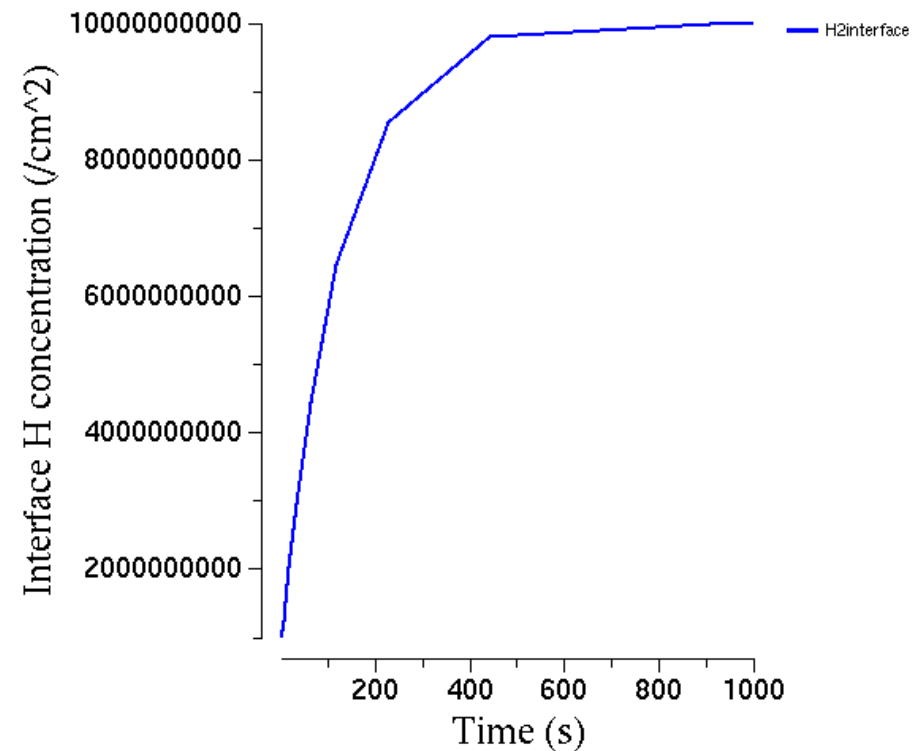
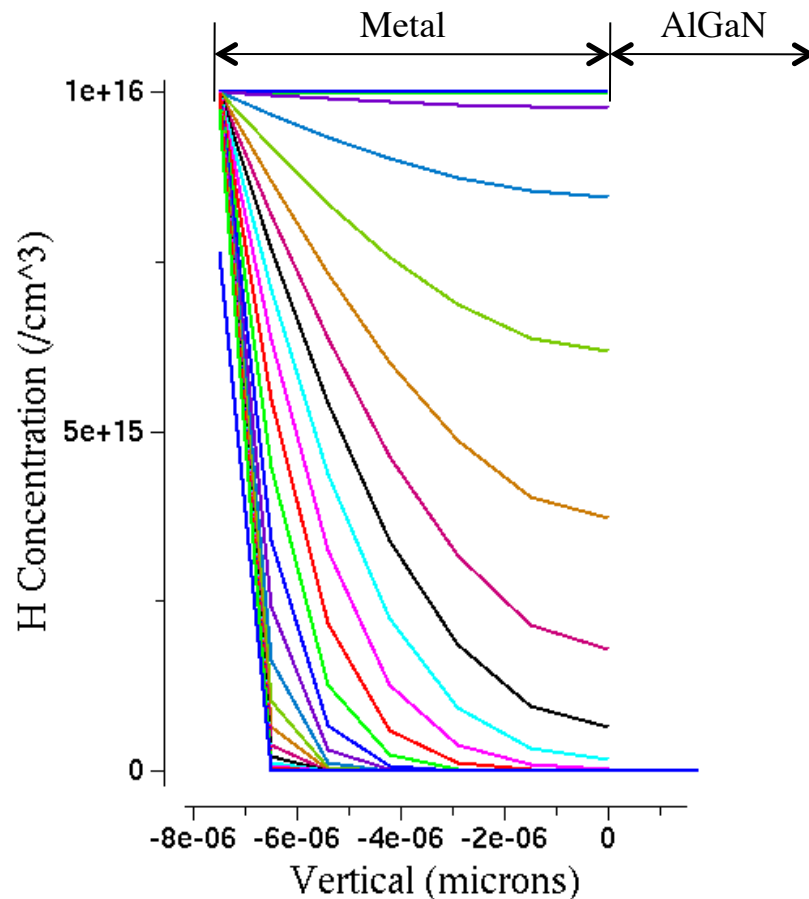
# Other Capabilities: AlGaN/GaN ChemFET

## H<sub>2</sub> Sensing with AlGaN/GaN HEMT



Wang et. al.. Appl. Phys. Lett. 87, 172105 (2005)

# Other Capabilities: AlGaIn/GaN ChemFET



H concentration saturates at  
Trap capacity =  $1.0 \times 10^{10} / \text{cm}^2$

# Summary and Future Work

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- FLOORS provides fully-coupled ETM simulation capabilities
  - Unique in that mechanical-induced electrical changes may be simulated
  - Validation with COMSOL
  - Convergence issues exist at high negative gate bias
- Future Work
  - Incorporate Poole-Frenkle emission as gate leakage model for bias conditions near the threshold voltage.



